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Cypress (NASDAQ: CY) delivers high-performance, high-quality solutions at the heart of today's most advanced embedded systems, from automotive, industrial and networking platforms to highly interactive consumer and mobile devices. With a broad, differentiated product portfolio that includes NOR flash memories, F-RAM™ and SRAM, Traveo™ microcontrollers, the industry's only PSoC® programmable system-on-chip solutions, analog and PMIC Power Management ICs, CapSense® capacitive touch-sensing controllers, and Wireless BLE Bluetooth® Low-Energy and USB connectivity solutions, Cypress is committed to providing its customers worldwide with consistent innovation, best-in-class support and exceptional system value.

F²MC Series
BGM ADAPTER
MB2146-09
OPERATION MANUAL

PREFACE

Thank you for purchasing the F²MC * series BGM adapter (model number MB2146-09). The product is a development support tool for developing and evaluating applied products which use Fujitsu microcontrollers (hereafter MCUs) incorporating BDSU modules. This manual describes how to handle the F²MC series BGM adapter. Be sure to read it before using the product. For information on the MCUs supported by this product, contact the Fujitsu sales or support representative.

* : F²MC is the abbreviation used for FUJITSU Flexible MICRO CONTROLLER.

■ For Your Safety

This manual contains important information required for using the product safely. Be sure to read through the manual before using the product and follow the instructions contained therein to use it correctly.

In particular, carefully read "Caution of the products described in this manual" at the beginning of this manual to understand the requirements for safe use of the product before using it. After reading the manual, keep it handy for future reference.

■ Warranty and Liability

The specifications of the product are subject to change without notice. Fujitsu assumes no liability for any loss or damage whatsoever directly or indirectly arising out of the use of the product.

■ Related Manuals

You should refer to the following manuals as well:

- "HARDWARE MANUAL" for each type of microcontroller
- "DATA SHEET" for each type of microcontroller
- "SOFTUNE Workbench OPERATION MANUAL"
- "SOFTUNE Workbench USER'S MANUAL"
- "SOFTUNE Workbench COMMAND REFERENCE MANUAL"

■ Caution of the products described in this document

The following precautions apply to the product described in this manual.



Indicates a potentially hazardous situation which, if not avoided appropriately, could result in death or serious injury and/or a fault in the user's system.

Electric shock, Damage	Before performing any operation described in this manual, turn off all the power supplies to the system. Performing such an operation with the power on may cause an electric shock or device fault.
Electric shock, Damage	Once the product has been turned on, do not touch any metal part of it. Doing so may cause an electric shock or device fault.

**CAUTION**

Indicates a potentially hazardous situation which, if not avoided appropriately, may result in minor or moderate injury and/or damage to the product or the equipment to which the product is connected, to software resources such as data, or to other properties.

Cuts, Damage	Before moving the product, be sure to turn off all the power supplies and unplug the cables. Watch your steps when carrying the product. Do not use the product at an unstable location such as a place exposed to strong vibration or a sloping surface. Doing so may let the product fall, resulting in an injury or fault.
Damage	Neither put anything on or apply shock to the product. Once the product has been powered, do not carry it. Doing either may cause a fault due to a load or shock.
Damage	Since the product contains many electronic components, keep it away from direct sunlight, high temperature, and high humidity to prevent condensation. Do not use or store the product where it is exposed to much dust or a strong magnetic or electric field for an extended period of time. An adverse operating or storage environment can cause a fault.
Damage	Use the product within the ranges of its general specifications. Please look at "4. Specifications" about the use range. Operating it outside the range of any general specification may cause a fault.
Damage	To prevent electrostatic breakdown, do not let your finger or an object touch any metal part of the connector. Before handling the product, touch a metal object (such as a door knob) to discharge static electricity from your body.
Damage	When turning the power on or off, follow the relevant procedure described in this document. Before turning the power on, in particular, be sure to finish making all the required connections. To set up and use the product, follow the instructions given in this document. Using the product incorrectly or inappropriately may cause a fault.
Damage	Before plugging or unplugging any cable for this product, be sure to turn the power supply off. When unplugging the cable, remove it while holding the connector without pulling the cable itself. Pulling the cable itself or bending it may expose or disconnect the cable core, resulting in a fault.
Damage	When stored, the product should be kept in its packaging box as it has no housing. Re-transporting the product may damage it to cause a fault. Keep the packaging materials used for shipment of the product and use them when re-transporting it.

- The contents of this document are subject to change without notice.
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- If any products described in this document represent goods or technologies subject to certain restrictions on export under the Foreign Exchange and Foreign Trade Law of Japan, the prior authorization by Japanese government will be required for export of those products from Japan.

1. Checking the Delivered Product

Before using the product, make sure that your package contains the following items:

- BGM adapter * : 1
- USB cable (2.0 m) : 1
- Operation manual (Japanese version) : 1
- Operation manual (English version - This document) : 1

* : Hereafter called the adapter.

2. Appearance and Part Names

Figures 1 and 2 show the adapter appearance, major dimensions and part names.

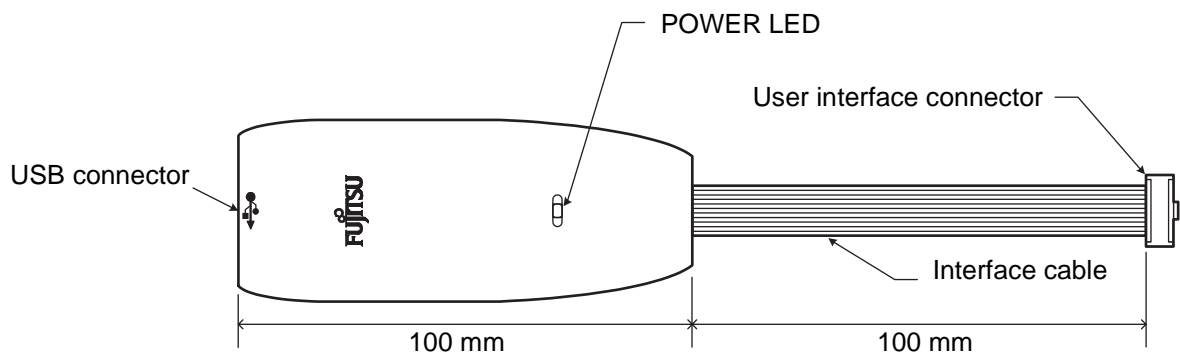


Figure 1 Adapter Appearance (Top view)

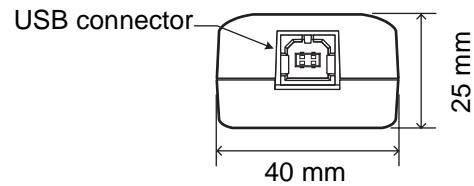


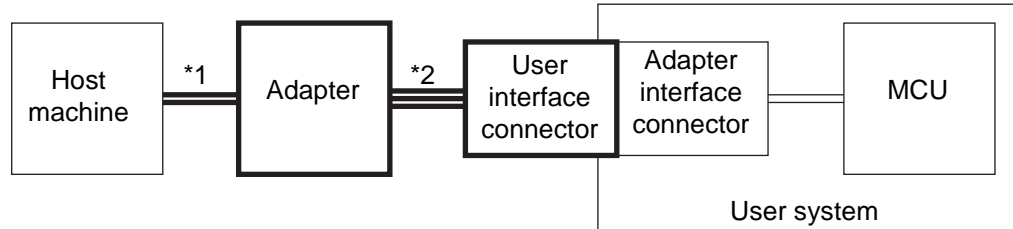
Figure 2 Adapter Appearance (Front view)

3. Connecting the Adapter

■ System Configuration (emulator system)

Connect the adapter between the host machine and the user system so that the adapter can serve as an emulator under control of the host machine. For using emulator debugger software on the host machine, refer to the "SOFTUNE Workbench OPERATION MANUAL".

Figure 3 shows the system configuration.



*1 : USB cable

*2 : Interface cable (adapter's flat cable)

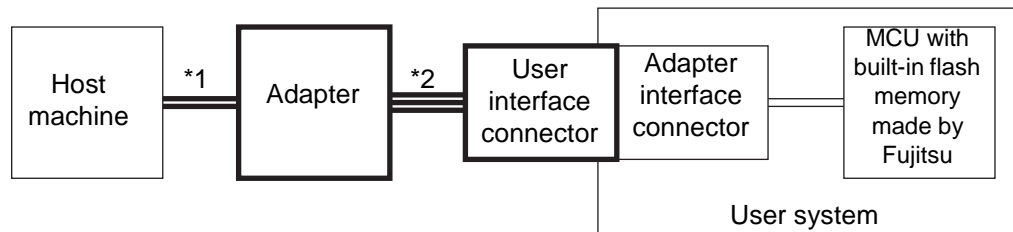
Figure 3 System Configuration (emulator system)

■ System Configuration (USB programmer)

The adapter connects the host machine and the serial interface of MCU with built-in flash memory made by Fujitsu, and writes data in a built-in flash memory.

For information on the USB programmer, contact the Fujitsu sales or support representative.

Figure 4 shows the system configuration.



*1 : USB cable

*2 : Interface cable (adapter's flat cable)

Figure 4 System Configuration (USB programmer)

■ **Connection to the Host Machine**

Connect the adapter to the host machine using the USB cable.
Figure 5 shows how to plug the USB cable.

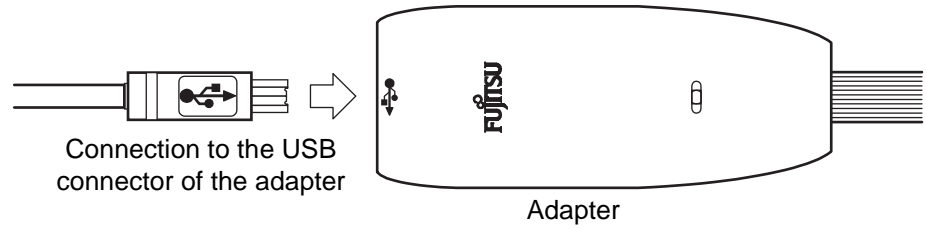


Figure 5 Plugging the USB Cable

■ **Connection to the User System**

Connect the adapter to the user system.
Plug the user interface connector of the adapter into the adapter interface connector on the user system.
When plugging the user interface connector, align its index mark (pin No. 1) with the adapter interface connector's counterpart.
For the specifications of the adapter interface connector, see "Adapter Interface Specifications" in Section 4 "Specifications".
Figure 6 shows how to connect the adapter to the user system.

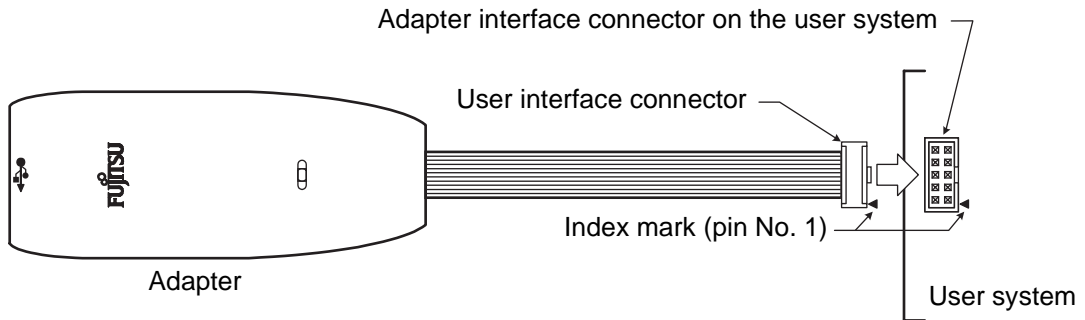


Figure 6 Connecting to the User System

4. Specifications

■ General Specifications

Table 1 lists the general specifications of the adapter.

Table 1 General Specifications

Item	Specification	
Name	F ² MC series BGM adapter	
Model number	MB2146-09	
Power supply specifications	Adapter power input	Max 50 mA (USB BUS power used)
	User power input	+2.7 V to +5.5 V *1 Max 20 mA *2
POWER LED indication	[Green]: On when only adapter power is supplied (with the USB cable connected). [Red]: On when only user power is supplied. [Orange]: On when both adapter power and user power are supplied.	
User interface connector *3	MIL standard compliant key type (with the center key)	
Operating temperature/humidity	+5 to +35 °C 20 to 80 % (No condensation allowed)	
Storage temperature/humidity	0 to +70 °C 20 to 80 % (No condensation allowed)	
Dimensions	Adapter case : 40 (W) × 100 (D) × 25 (H) mm (Protrusions excluded)	
	Interface cable length: 100 mm (User interface connector excluded)	
Weight	55 g	

*1 : The maximum and minimum voltages depends on the MCU used.

For details, contact the Fujitsu sales or support representative.

*2 : The power consumption by the MCU used is not included.

*3 : The connector part number is given below.

FAS-1001-2101-0BF (YAMAICHI ELECTRONICS Co., Ltd.)

■ USB Line Specifications

Table 2 lists the USB line specifications of the adapter.

Table 2 USB Line Specifications

Item	Description
Conforming standard	USB1.1
Communication method	Full Speed Bulk Transfer
Data transfer rate	12Mbps
Connector shape	Series B
Power supply	BUS Powered

■ Tool Reset Specifications

A tool reset is a hardware reset by the adapter to reset the entire system of the MCU (including the BDSU module) on the user system.

When both of the adapter power and MCU's user power are turned on, the tool reset is canceled automatically to enable the MCU to be evaluated.

The following shows how to generate a tool reset and how long it remains in effect.

- Tool reset generation methods and reset "L" pulse width

- 1) Set the MCU user power from OFF to ON (power-on reset).

The reset remains in effect for about 16 to 70 ms after the MCU user power is supplied.

- 2) Set the adapter power from OFF to ON (by unplugging and plugging the USB cable).

The reset remain in effect for about 32 to 140 ms after the adapter power is supplied.

If the user system and adapter cause an uncontrollable error but the system cannot be recovered by tool reset generation method 1), execute tool reset generation method 2).

■ Adapter Interface Specifications

Table 3 is a pinout of the adapter interface connector mounted on the user system. Table 5 lists recommended connectors. Figure 7 shows the connector pins.

When the adapter interface connector is installed on the user system, connect the adapter interface connector to the MCU according to the following specifications.

Table 3 Adapter Interface Connector Pinout (emulator system)

Connector pin No.	Input / output *	Evaluation MCU connection terminal	Function	Remarks
1	BGMA <- MCU	UVCC	User power supply input	Connected to the MCU's Vcc pin.
2	—	GND	Vss	Connected to the MCU's Vss pin.
3	BGMA -> MCU	TRESETX	Tool reset output	BDSU, Initialization of user's logic
4	BGMA -> MCU	DMDX	Mode change output	0 : Debug mode 1 : Free run mode
5	BGMA <- MCU	SOUT	Serial data input	SD for UART
6	BGMA <- MCU	EXC	External clock input	Base clock for UART
7	BGMA -> MCU	SIN	Serial data output	RD for UART
8	—	N.C	Not used	Not connected
9	—	GND	Vss	Connected to the MCU's Vss pin.
10	BGMA <- MCU	UVCC	User power supply input	Connected to the MCU's Vcc pin.

* : "BGMA" and "MCU" in the "Input/output" column in the table indicates the "BGM adapter" and "Evaluation MCU" respectively.

Table 4 Adapter Interface Connector Pinout (USB programmer)

Connector pin No.	Input / output *1	Evaluation MCU connection terminal	Function	Remarks
1	BGMA <- MCU	UVCC	User power supply input	Connected to the MCU's Vcc pin.
2	—	GND	Vss	Connected to the MCU's Vss pin.
3	BGMA -> MCU	RSTX	Tool reset output	BDSU, Initialization of user's logic
4	—	N.C	Mode change output	Not used. Not connected.
5	BGMA <- MCU	UOx *2	Serial data input	SD for UART
6	BGMA -> MCU	UCKx *2	Synchronous clock output	Base clock for UART
7	BGMA -> MCU	UIx *2	Serial data output	RD for UART
8	—	N.C	Not used	Not connected
9	—	GND	Vss	Connected to the MCU's Vss pin.
10	BGMA <- MCU	UVCC	User power supply input	Connected to the MCU's Vcc pin.

*1 : "BGMA" and "MCU" in the "Input/output" column in the table indicates the "BGM adapter" and "Evaluation MCU" respectively.

*2 : Please refer to each MCU specifications for the serial port number that corresponds to the serial interface for the USB programmer.

Table 5 Recommended Adapter Interface Connectors

Part number	Specifications		Manufacturer
FAP-1001-2202-0BS	Right-angle solder dip	Housing provided Middle latch provided	YAMAICHI ELECTRONICS Co., Ltd.
FAP-1001-2204-0BS	Straight solder dip	Housing provided Middle latch provided	
FAP-10-08#2-0BS	Right-angle solder dip	Housing provided Latch not provided	
FAP-10-08#4-0BS	Straight solder dip	Housing provided Latch not provided	

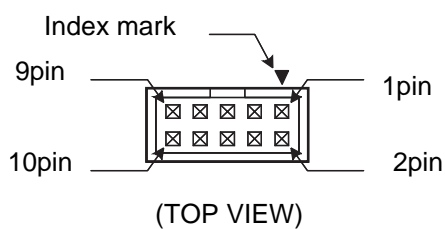


Figure 7 Adapter Interface Connector Pins

■ Options

Various options are available to the adapter. Purchase them as required. See Table 6 for the options.

Table 6 Options

Name	Part number
MCU *	MBxxxxx

*: The part number depends on the MCU used.

For details, contact the Fujitsu sales or support representative.

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FUJITSU SEMICONDUCTOR • SUPPORT SYSTEM

F²MC Series
BGM ADAPTER
MB2146-09
OPERATION MANUAL

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